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Metallic **communication cables and other passive components –
Test methods –
Part 4-8: Electromagnetic compatibility (EMC) – Capacitive coupling admittance**

INTERNATIONAL
ELECTROTECHNICAL
COMMISSION

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CONTENTS

FOREWORD.....	4
1 Scope.....	6
2 Normative references.....	6
3 Terms and definitions	6
Test equipment.....	
General.....	
Capacitance bridge method.....	
Pulse method	
Procedure	
Capacitance bridge method.....	
Pulse method	
Measurement precautions.....	
Capacitance bridge method.....	
Pulse method	
Expression of results.....	
Determination of the capacitive or capacitance transfer impedance Z_F	
Requirement.....	
4 Principle	14
5 Test method	14
5.1 General.....	14
5.2 Cut-off frequency	15
5.3 Test equipment	15
5.4 Coupling length	15
5.5 Sample preparation.....	15
5.6 Test set-up.....	16
5.7 Calibration procedure	17
5.8 Measuring procedure.....	18
5.9 Evaluation of test results	18
5.9.1 General	18
5.9.2 Test report.....	19
Bibliography	20

~~Figure — Layout of the test circuit for the measurement of through capacitance by capacitance bridge method~~

~~Figure — Layout of test circuit for the measurement of through capacitance by pulse method~~

~~Figure — Layout of test circuit for time domain measurement~~

Figure 1 – Definition of Z_T	6
Figure 2 – Definition of Z_F	7
Figure 3 – Preparation of test sample for coaxial cables	11
Figure 4 – Preparation of test sample for symmetrical cables.....	12
Figure 5 – Triaxial set-up	12
Figure 6 – Connection to the vector network analyzer	13

INTERNATIONAL ELECTROTECHNICAL COMMISSION

**METALLIC-~~COMMUNICATION~~ CABLES
AND OTHER PASSIVE COMPONENTS –
TEST METHODS –****Part 4-8: Electromagnetic compatibility (EMC) –
Capacitive coupling admittance****FOREWORD**

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International Standard IEC 62153-4-8 has been prepared by IEC technical committee 46: Cables, wires, waveguides, RF connectors, RF and microwave passive components and accessories.

This second edition cancels and replaces the first edition published in 2006. This edition constitutes a technical revision.

Future standards in this series will carry the new general title as cited above. Titles of existing standards in this series will be updated at the time of the next edition.

This edition includes the following significant technical changes with respect to the previous edition:

- a) use of the triaxial set-up in a similar manner as for the measurement of the transfer impedance (see IEC 62153-4-3),
- b) use of vector network analyser instead of capacitance bridge or pulse generator.

The text of this International Standard is based on the following documents:

FDIS	Report on voting
46/684/FDIS	46/690/RVD

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts of the IEC 62153 series, under the general title: *Metallic cables and other passive components – Test methods*, can be found on the IEC website.

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**METALLIC ~~COMMUNICATION~~ CABLES
AND OTHER PASSIVE COMPONENTS –
TEST METHODS –**

**Part 4-8: Electromagnetic compatibility (EMC) –
Capacitive coupling admittance**

1 Scope

This part of IEC 62153 ~~applies to metallic communications cables. It specifies a test method for determining the capacitive coupling admittance by the measurement of through capacitance using either a capacitance bridge or by a pulse method~~ the capacitive coupling impedance and the coupling capacitance by the use of a triaxial set-up in a similar manner as for the measurement of the transfer impedance (see IEC 62153-4-3). Most cables have negligible capacitive coupling; however, in the case of cables with loose single-braids, the coupling through the holes in the screen shall be determined by the measurement of the capacitive coupling admittance.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

~~IEC 60050-726, International Electrotechnical Vocabulary (IEV) — Part 726: Transmission lines and wave guides~~

~~IEC 61196-1, Coaxial communication cables — Part 1: Generic specification — General, definitions and requirements~~

~~IEC 62153-4-1, Metallic communication cable test methods — Part 4-1: Electromagnetic Compatibility (EMC) — Introduction to electromagnetic (EMC) screening measurements⁴~~

IEC 62153-4-3, Metallic communication cable test methods — Part 4-3: Electromagnetic compatibility (EMC) — Surface transfer impedance — Triaxial method

⁴~~To be published.~~

INTERNATIONAL STANDARD

NORME INTERNATIONALE



**Metallic cables and other passive components – Test methods –
Part 4-8: Electromagnetic compatibility (EMC) – Capacitive coupling admittance**

**Câbles métalliques et autres composants passifs – Méthodes d'essai –
Partie 4-8: Compatibilité électromagnétique (CEM) – Admittance de couplage capacitif**



CONTENTS

FOREWORD.....	3
1 Scope.....	5
2 Normative references.....	5
3 Terms and definitions	5
4 Principle	9
5 Test method	9
5.1 General.....	9
5.2 Cut-off frequency	9
5.3 Test equipment	9
5.4 Coupling length.....	9
5.5 Sample preparation.....	10
5.6 Test set-up.....	11
5.7 Calibration procedure	12
5.8 Measuring procedure.....	12
5.9 Evaluation of test results	12
5.9.1 General	12
5.9.2 Test report.....	13
Bibliography	14
Figure 1 – Definition of Z_T	6
Figure 2 – Definition of Z_F	7
Figure 3 – Preparation of test sample for coaxial cables	10
Figure 4 – Preparation of test sample for symmetrical cables.....	10
Figure 5 – Triaxial set-up	11
Figure 6 – Connection to the vector network analyzer.....	11

INTERNATIONAL ELECTROTECHNICAL COMMISSION

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TEST METHODS –****Part 4-8: Electromagnetic compatibility (EMC) –
Capacitive coupling admittance****FOREWORD**

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METALLIC CABLES AND OTHER PASSIVE COMPONENTS – TEST METHODS –

Part 4-8: Electromagnetic compatibility (EMC) – Capacitive coupling admittance

1 Scope

This part of IEC 62153 specifies a test method for determining the capacitive coupling admittance, the capacitive coupling impedance and the coupling capacitance by the use of a triaxial set-up in a similar manner as for the measurement of the transfer impedance (see IEC 62153-4-3). Most cables have negligible capacitive coupling; however, in the case of cables with loose single-braids, the coupling through the holes in the screen shall be determined by the measurement of the capacitive coupling admittance.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 62153-4-3, *Metallic communication cable test methods – Part 4-3: Electromagnetic compatibility (EMC) – Surface transfer impedance – Triaxial method*

SOMMAIRE

AVANT-PROPOS	17
1 Domaine d'application.....	19
2 Références normatives	19
3 Termes et définitions	19
4 Principe.....	23
5 Méthode d'essai	23
5.1 Généralités	23
5.2 Fréquence de coupure	23
5.3 Matériel d'essai.....	23
5.4 Longueur de couplage	24
5.5 Préparation de l'échantillon	24
5.6 Montage d'essai.....	25
5.7 Procédure d'étalonnage	26
5.8 Procédure de mesure	26
5.9 Évaluation des résultats d'essai.....	26
5.9.1 Généralités	26
5.9.2 Rapport d'essai.....	27
Bibliographie	28
Figure 1 – Définition de Z_T	20
Figure 2 – Définition de Z_F	21
Figure 3 – Préparation de l'échantillon d'essai pour les câbles coaxiaux	24
Figure 4 – Préparation de l'échantillon d'essai pour câbles à paires symétriques.....	25
Figure 5 – Montage triaxial.....	25
Figure 6 – Raccordement à l'analyseur de réseau vectoriel.....	26

COMMISSION ÉLECTROTECHNIQUE INTERNATIONALE

**CÂBLES MÉTALLIQUES ET AUTRES COMPOSANTS PASSIFS –
MÉTHODES D'ESSAI –****Partie 4-8: Compatibilité électromagnétique (CEM) –
Admittance de couplage capacitif****AVANT-PROPOS**

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Cette deuxième édition annule et remplace la première édition parue en 2006. Cette édition constitue une révision technique.

Les futures normes de cette série porteront dorénavant le nouveau titre général cité ci-dessus. Le titre des normes existant déjà dans cette série sera mis à jour lors de la prochaine édition.

Cette édition inclut les modifications techniques majeures suivantes par rapport à l'édition précédente:

- a) l'utilisation d'un montage triaxial similaire à celui utilisé pour le mesurage de l'impédance de transfert (voir l'IEC 62153-4-3),
- b) l'utilisation d'un analyseur de réseau vectoriel en lieu et place d'un pont capacitif ou d'un générateur d'impulsions.

Le texte de cette Norme internationale est issu des documents suivants:

FDIS	Rapport de vote
46/684/FDIS	46/690/RVD

Le rapport de vote indiqué dans le tableau ci-dessus donne toute information sur le vote ayant abouti à l'approbation de cette Norme internationale.

Ce document a été rédigé selon les Directives ISO/IEC, Partie 2.

Une liste de toutes les parties de la série IEC 62153, publiées sous le titre général: *Câbles métalliques et autres composants passifs – Méthodes d'essai*, peut être consultée sur le site web de l'IEC.

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CÂBLES MÉTALLIQUES ET AUTRES COMPOSANTS PASSIFS – MÉTHODES D'ESSAI –

Partie 4-8: Compatibilité électromagnétique (CEM) – Admittance de couplage capacitif

1 Domaine d'application

La présente partie de l'IEC 62153 spécifie une méthode d'essai pour la détermination de l'admittance de couplage capacitif, l'impédance de couplage capacitif et la capacité de couplage par l'utilisation d'un montage triaxial similaire à celui utilisé pour le mesurage de l'impédance de transfert (voir l'IEC 62153-4-3). La plupart des câbles présentent un couplage capacitif négligeable. Cependant, dans le cas d'un câble à tressage individuel détendu, le couplage à travers les trous de l'écran doit être déterminé par le mesurage de l'admittance de couplage capacitif.

2 Références normatives

Les documents suivants cités dans le texte constituent, pour tout ou partie de leur contenu, des exigences du présent document. Pour les références datées, seule l'édition citée s'applique. Pour les références non datées, la dernière édition du document de référence s'applique (y compris les éventuels amendements).

IEC 62153-4-3, *Metallic communication cable test methods – Part 4-3: Electromagnetic compatibility (EMC) – Surface transfer impedance – Triaxial method* (disponible en anglais seulement)